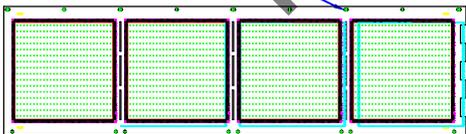


框架传送方向 (装片):  
L/F Direction (D/A):

椭圆孔



注意: 基岛全镀银

实物图:  
Chip photo:

特殊说明 Special Instructions:

DFN12L (3X1.5X0.5-P0.45) (112X32mil<sup>2</sup>) (4block)  
(2850X810um<sup>2</sup>)